

LC/LW010- and LC/LW015-Series Power Modules: 18 Vdc to 36 Vdc or 36 Vdc to 75 Vdc Inputs, 10 W and 15 W



The LC/LW010- and LC/LW015-Series Power Modules use advanced, surface-mount technology and deliver high-quality, compact, dc-dc conversion at an economical price.

Options

- n Remote on-off
- n Choice of on/off configuration
- ⁿ Short pin: 2.8 mm ± 0.25 mm (0.110 in. ± 0.010 in.)
- Synchronization (cannot be ordered on units with remote on/off)
- Output voltage adjust: 90% to 110% of Vo, nom (single outputs only)
- n Tight output voltage tolerance

Features

- Low profile: 10.2 mm x 25.4 mm x 50.8 mm (0.4 in. x 1.0 in. x 2.0 in.) with standoffs (9.6 mm (0.38 in.) with standoffs recessed)
- Wide input voltage range: 18 Vdc to 36 Vdc or 36 Vdc to 75 Vdc
- n Output current limiting, unlimited duration
- n Output overvoltage clamp
- n Undervoltage lockout
- _n Input-to-output isolation: 1500 V
- Operating case temperature range: –40 °C to +105 °C
- UL* 1950 Recognized, CSA[†] 22.2 No. 950-95 Certified, IEC950, and VDE0805 Licensed
- n CE mark meets 73/23/EEC and 93/68/EEC directives[‡]
- n Within FCC and VDE Class A radiated limits

Applications

- n Telecommunications
- n Distributed power architectures
- n Private branch exchange (PBX)
- Noice and data multiplexing

Description

The L Single- and Dual-Output-Series Power Modules are low-profile, dc-dc converters that operate over an input voltage range of 18 Vdc to 36 Vdc or 36 Vdc to 75 Vdc and provide one or two precisely regulated outputs. The outputs are isolated from the input, allowing versatile polarity configurations and grounding connections. The modules have a maximum power rating of 10 W to 15 W and efficiencies of up to 84% for a 5 V output and 82% for a 3.3 V output. Built-in filtering for both input and output minimizes the need for external filtering.

- * UL is a registered trademark of Underwriters Laboratories, Inc.
- † CSA is a registered trademark of Canadian Standards Association.
- ‡ This product is intended for integration into end-use equipment. All the required procedures for CE marking of end-use equipment should be followed. (The CE mark is placed on selected products.)

Absolute Maximum Ratings

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operations sections of the data sheet. Exposure to absolute maximum ratings for extended periods can adversely affect device reliability.

Parameter	Device	Symbol	Min	Тур	Max	Unit
Input Voltage:						
Continuous	LC	Vı	0	_	50	Vdc
	LW	Vı	0	_	80	Vdc
Transient (100 ms)	LW	VI, trans	0	_	100	V
Operating Case Temperature	All	Tc	-40	_	105*	°C
(See Derating Curves, Figures 43—45.)						
Storage Temperature	All	Tstg	- 55	_	125	°C
I/O Isolation	All	_	_	_	1500	Vdc

^{*} Maximum case temperature varies based on power dissipation. See derating curves, Figures 43—45, for details.

Electrical Specifications

Table 1. Input Specifications

Parameter	Device	Symbol	Min	Тур	Max	Unit
Operating Input Voltage	LC	Vı	18	24	36	Vdc
	LW	Vı	36	48	75	Vdc
Maximum Input Current	LC	II, max	_	_	1.6	Α
(VI = 0 to VI, max; Io = Io, max; see Figures	LW	II, max	_	_	800	mA
1—4.)						
Inrush Transient	All	I ² t	_	_	0.2	A ² s
Input Reflected-ripple Current (5 Hz to 20 MHz; 12 µH source impedance; TA = 25 °C; see Figure 33.)	All	lı	_	5	_	тАр-р
Input Ripple Rejection (100 Hz—120 Hz)	All	_	_	45	_	dB

Fusing Considerations

CAUTION: This power module is not internally fused. An input line fuse must always be used.

This encapsulated power module can be used in a wide variety of applications, ranging from simple stand-alone operation to an integrated part of a sophisticated power architecture. To preserve maximum flexibility, internal fusing is not included; however, to achieve maximum safety and system protection, always use an input line fuse. The safety agencies require a normal-blow, dc fuse with a maximum rating of 5 A (see Safety Considerations section). Based on the information provided in this data sheet on inrush energy and maximum dc input current, the same type of fuse with a lower rating can be used. Refer to the fuse manufacturer's data for further information.

Table 2. Output Specifications

Parameter	Device Code or Suffix	Symbol	Min	Тур	Max	Unit
Output Voltage Set Point	D	Vo, set	1.92	2.0	2.08	Vdc
(VI = VI, nom; IO = IO, max; TA = 25 °C)	G*	Vo, set	_	2.5		Vdc
,	F	Vo, set	3.17	3.3	3.43	Vdc
	Α	Vo, set	4.85	5.0	5.20	Vdc
	В	Vo, set	11.52	12.0	12.48	Vdc
	С	Vo, set	14.40	15.0	15.60	Vdc
	AJ	Vo1, set	4.75	5.0	5.25	Vdc
		Vo2, set	-4.75	-5.0	-5.25	Vdc
	BK	Vo1, set	11.40	12.0	12.60	Vdc
		VO2, set	-11.40	-12.0	-12.60	Vdc
	CL	VO1, set	14.25	15.0	15.75	Vdc
		VO2, set	-14.25	-15.0	-15.75	Vdc
Output Voltage	D	Vo, set	1.90	-	2.10	Vdc
(Over all line, load, and temperature	G*	Vo, set	_	2.5	_	Vdc
conditions until end of life; see	F	Vo, set	3.13	_	3.47	Vdc
Figures 35 and 37.)	Α	Vo, set	4.80	_	5.25	Vdc
	В	Vo, set	11.40	_	12.60	Vdc
	С	Vo, set	14.25	_	15.75	Vdc
	AJ	VO1, set	4.5	_	5.5	Vdc
		VO2, set	-4 .5	_	-5.5	Vdc
	BK	VO1, set	10.80	_	13.20	Vdc
		VO2, set	-10.80	_	-13.20	Vdc
	CL	Vo1, set	13.50	_	16.50	Vdc
		Vo2, set	-13.50	_	-16.50	Vdc
Output Regulation						
(See Figures 5—11):						
Line (VI = VI, min to VI, max)	A, F, D, G*	_	_	_	5	mV
	B, C	_	_	0.01	0.1	%Vo
Load (Io = Io, min to Io, max)	Lx010 A, F, D, G*	_	_	_	10	mV
	B, C	_	_	0.1	0.2	%Vo
Load (Io = Io, min to Io, max)	Lx015 A, F, D, G*	_	_	_	15	mV
	B, C	_	_	0.1	0.2	%Vo
Temperature	A, F, D, G*	_	_	25	100	mV
(Tc = -40 °C to +85 °C)	B, C	_	_	0.5	2.0	%Vo
Output Ripple and Noise						
(Across 2 x 0.47 μF ceramic capaci-						
tors; see Figures 34 and 36.):						
RMS	A, D, F, G*	_	_	_	30	mVrms
	AJ, B, C	_	_	_	35	mVrms
	BK, CL	_	_	_	50	mVrms
Peak-to-peak (5 Hz to 20 MHz)	A, D, F, G*	_	_	_	100	mVp-p
	AJ, B, C	_	_	_	120	mVp-p
	BK, CL	_	_	_	150	mVp-p
External Load Capacitance	A, F, D, G*	_	_	_	1000	μF
	B, C	_	_	_	200	μF

^{*} For a 2.5 V output, use the 2 V output module (D code) with an output voltage trim pin (optional feature).

Table 2. Output Specifications (continued)

Parameter	Device Code or Suffix	Symbol	Min	Тур	Max	Unit
Output Current	Lx015D	lo	0.35	_	3.0	Α
(At Io < Io, min, the modules may	Lx015F	lo	0.25	_	3.0	Α
exceed output ripple specifications,	Lx015A	lo	0.15	_	3.0	Α
but operation is guaranteed.)	Lx015B	lo	0.12	_	1.25	Α
Note: On the Lx01xF, the output	Lx015C	lo	0.10	_	1.0	Α
voltage may exceed	Lv040D C*		0.0		2.0	Λ .
specifications when	Lx010D, G*	lo	0.2	_	2.0	A
IO < IO, min.	Lx010F	lo	0.15	_	2.42	A
	Lx010A	lo	0.1	_	2.0	A
	Lx010B	lo	0.08	_	0.83	A
	Lx010C	lo	0.06	_	0.67	Α
	Lx010AJ	lo1, lo2	0.1	_	1.0	Α
	Lx010BK	lo1, lo2	0.06	_	0.42	Α
	Lx010CL	lo1, lo2	0.05	_	0.33	Α
Output Current-limit Inception	Lx015D	lo	_	_	7.5	Α
(Vo = 90% Vo, set; see Figures	Lx015F	lo	_	_	6.5	Α
12—14.)	Lx015A	lo	_	_	5	Α
,	Lx015B	lo	_	_	3.1	Α
	Lx015C	lo	_	_	2.5	Α
	Lx010D, G*	lo	_	_	7.0	Α
	Lx010F	lo	_	_	5	Α
	Lx010A	lo	_	_	4	Α
	Lx010B	lo	_	_	2.5	Α
	Lx010C	lo	_	_	2	Α
	Lx010AJ	lo1, lo2	_	_	4.0	Α
	Lx010BK	lo1, lo2	_	_	2.5	A
	Lx010CL	lo1, lo2		_	2.5	A
Output Short-circuit Current	Lx015D	lo	_	_	8.5	Α
(Vo = 0.25 V)	Lx015F	lo	_	_	8.5	A
(**************************************	Lx015A	lo	_	_	7.5	A
	Lx015B	lo	_	_	4.5	A
	Lx015C	lo	_	_	4.5	A
	Lx010D, G*	lo	_	_	8	
	Lx010D, G	lo	_	_	o 7.5	A
	Lx010F Lx010A	lo	_	_	7.5 6	A
	Lx010B	lo	_	_	3.5	A
	Lx010B	lo		_	3.5	A A
	Lx010AJ	lo1, lo2	_	_	6.0	A
	Lx010BK	lo1, lo2	_	_	3.5	A
	Lx010CL	lo1, lo2	-	_	3.5	Α

^{*} For a 2.5 V output, use the 2 V output module (D code) with an output voltage trim pin (optional feature).

Table 2. Output Specifications (continued)

Parameter	Device Code or Suffix	Symbol	Min	Тур	Max	Unit
Efficiency	LC015D	η	64	67		%
(VI = VI, nom; IO = IO, max; TA = 25 °C;	LC015F	η	74	77	_	%
see Figures 15—28, 35, and 37.)	LC015A	η	77	80	_	%
	LC015B, C	η	73	76	_	%
	LC010D, G*	η	65	68	_	%
	LC010F	η	71	75	_	%
	LC010A, B, C	ή	75	79	_	%
	LC010AJ, BK, CL	η	75	78	_	%
	LW015D	η	66	69	_	%
	LW015F	η	76	79	_	%
	LW015A	ή	79	82	_	%
	LW015B, C	η	75	78	_	%
	LW010D, G*	η	67	70	_	%
	LW010F	ή	73	76	_	%
	LW010A, B, C	η	77	81	_	%
	LW010AJ, BK, CL	η	77	80		%
Efficiency	LC015F	η	_	79		%
(VI = VI, nom; Io = 2 A; TA = 25 °C;	LC015A	η	_	82	_	%
see Figures 15, 18, 22, and 25.)	LW015F	η	_	82	_	%
	LW015A	η		84	_	%
Switching Frequency	All	_		265	_	kHz
Dynamic Response						
(for duals: lo1 or lo2 = lo, max;						
$\Delta Io/\Delta t = 1A/10 \ \mu s; \ V_I = V_{I, nom};$						
$T_A = 25 ^{\circ}\text{C}$; see Figures 29 and 30.):						
Load Change from Io = 50% to 75%						
of Io, max:	A 11			_		0/1/-
Peak Deviation	AII AII	_		2 0.8	_	%Vo, set
Settling Time	All	_	_	0.8	_	ms
(Vo < 10% of peak deviation) Load Change from Io = 50% to 25%						
of lo, max:						
Peak Deviation	All	_	_	2	_	%Vo, set
Settling Time	All		_	0.8		76 v O, set ms
(Vo < 10% of peak deviation)	/\li			0.0		1113
(VO > 10/0 of peak deviation)						

^{*} For a 2.5 V output, use the 2 V output module (D code) with an output voltage trim pin (optional feature).

Table 3. Isolation Specifications

Parameter	Min	Тур	Max	Unit
Isolation Capacitance	_	600	_	pF
Isolation Resistance	10	_	_	MΩ

Table 4. General Specifications

Parameter	Min	Тур	Max	Unit
Calculated MTBF (Io = 80% of Io, max; Tc = 40 °C):				
Lx010	_	7,800,000	_	hours
Lx015		5,400,000	_	hours
Weight	_	_	28.3 (1.0)	g (oz.)
Hand Soldering	_	_	12	S
(soldering iron 3 mm (0.125 in.) tip, 425 °C)				

Table 5. Feature Specifications

Remote On/Off Signal Interface (optional): (Vi = 0 V to Vi, max; open collector or equivalent compatible; signal referenced to Vi(-) terminal. See Figure 38 and Feature Descriptions.): Positive Logic — Device Code Suffix "4": Logic Low—Module Off Logic Low—Module On Negative Logic—Device Code Suffix "1": Logic Low—Module On Logic High—Module Off Module Specifications: On/Off Current—Logic Low On/Off Voltage: Logic Low Logic High (Ion/off = 0) Open Collector Switch Specifications: Leakage Current During Logic High (Von/off = 10 V) Output Low Voltage During Logic Low (Ion/off = 1 mA) Turn-on Delay and Rise Times (At 80% of Io. max; Ta = 25 °C; see Figures 31 and 32.): Case 1: On/Off Input Is Set for Unit On and then Input Power Is Applied (delay from point at which V = VI, min until Vo = 10% of VO, nom). Case 2: Input Power Is Applied for at Least One Second, and then the On/Off Input Is Set for Unit Voltage Rise Time (time for Vo to rise from 10% of VO, nom to 90% of VO, nom) Output Voltage Rise Time (time for Vo to rise from 10% of VO, nom to 90% of VO, nom) Output Voltage Rise Time (Voltage Rise Rise Rise Rise Rise Rise Rise Ris	Parameter	Device Code or Suffix	Symbol	Min	Тур	Max	Unit
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Logic High (Ion/off = 0) Open Collector Switch Specifications: Leakage Current During Logic High (Von/off = 10 V) Output Low Voltage During Logic Low (Ion/off = 1 mA) Turn-on Delay and Rise Times (At 80% of Io, max; TA = 25 °C; see Figures 31 and 32.): Case 1: On/Off Input Is Set for Unit On and then Input Power Is Applied (delay from point at which VI = VI, min until Vo = 10% of Vo, nom). Case 2: Input Power Is Applied for at Least One Second, and then the On/Off Input Is Set to Turn the Module On (delay from point at which on/off input is toggled until Vo = 10% of Vo, nom). Output Voltage Rise Time (time for Vo to rise from 10% of Vo, nom) All Von/off — — 50 µA All Von/off — — 50 µA All Tdelay — 5 20 ms Tdelay — 5 20 ms All Tdelay — 1 10 ms All Tdelay — 1 7 10 ms All Trise — 0.2 5 ms							
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point at which on/off input is toggled until Vo = 10% of Vo, nom). Output Voltage Rise Time (time for Vo to rise from 10% of Vo, nom to 90% of Vo, nom) All Trise — 0.2 5 ms	·						
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Output Voltage Rise Time (time for Vo to rise from 10% of Vo, nom to 90% of Vo, nom)							
(time for Vo to rise from 10% of Vo, nom to 90% of Vo, nom)	. ,		_			_	
90% of Vo, nom)		All	I rise	_	0.2	5	ms
	Output Voltage Overshoot	^				E	%
(at 80% of Io, max; TA = 25 °C)		All	_	_	_	5	70

Table 5. Feature Specifications (continued)

Parameter	Device Code or Suffix	Symbol	Min	Тур	Max	Unit
Output Voltage Set-point Adjustment Range	A, B, F	_	90	_	110	%Vo, nom
(optional: single outputs only)	С	_	90		100	%Vo, nom
	D	_	90	_	125	%Vo, nom
Output Overvoltage Clamp	D	Vo, clamp	2.60	_	4.0	V
(Vo, clamp may be set higher on units with out-	F	Vo, clamp	3.7		5.7	V
put voltage set-point adjustment option.)	Α	Vo, clamp	5.6		7.0	V
	В	Vo, clamp	13.2		16.0	V
	С	VO, clamp	16.5	_	21.0	V
	AJ	VO1, clamp	5.6		7.0	V
		VO2, clamp	-5.6	_	-7.0	V
	BK	VO1, clamp	13.2	_	18.0	V
		VO2, clamp	-13.2		-18.0	V
	CL	VO1, clamp	16.5	_	21.0	V
		VO2, clamp	-16.5		-21.0	V
Undervoltage Lockout	LCxxx	Vuvlo	11	14	_	V
-	LWxxx	Vuvlo	20	27	_	V

Characteristic Curves

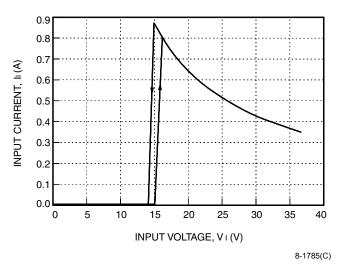


Figure 1. LC010 Input Current vs. Input Voltage at Io = Io, \max and Tc = 25 °C

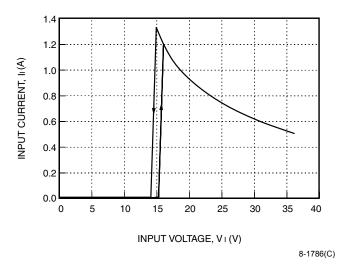


Figure 2. LC015 Input Current vs. Input Voltage at Io = Io, max and Tc = 25 °C

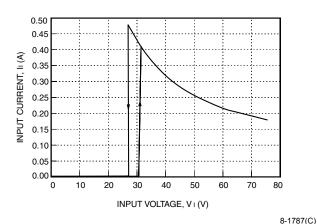


Figure 3. LW010 Input Current vs. Input Voltage at Io = Io, max and Tc = 25 °C

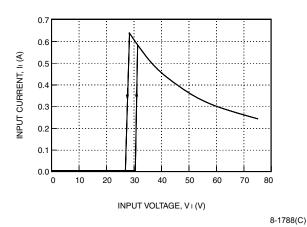


Figure 4. LW015 Input Current vs. Input Voltage at Io = Io, max and Tc = 25 °C

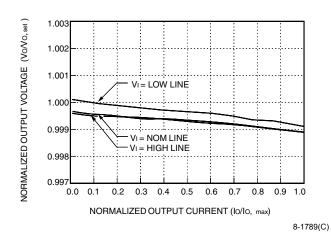
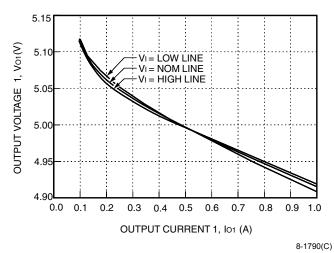
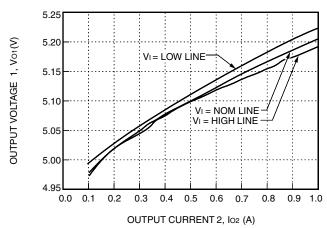


Figure 5. Lx010x/Lx015x Single-Output Load Regulation, Normalized Output Voltage vs. Normalized Output Current at Tc = 25 °C



Note: Output2 has characteristics similar to output1 when lo1 = 0.5 A and lo2 varies.

Figure 6. Lx010AJ Typical Load Regulation of Output1 with Fixed Io2 = 0.5 A at Tc = 25 °C

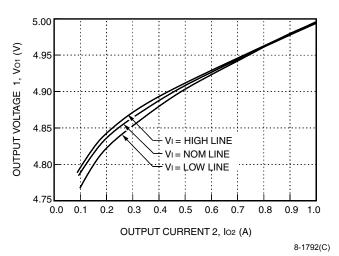


Note: Output2 has characteristics similar to output1 when lo2 = 0.1 A and lo1 varies.

Figure 7. Lx010AJ Typical Cross Regulation, Vo1 vs. lo2 with Fixed lo1 = 0.1 A at Tc = 25 °C

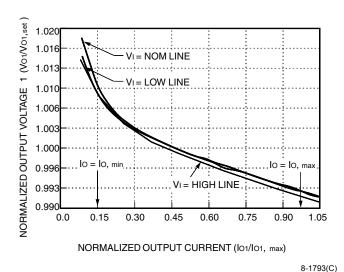
8-1791(C)

8



Note: Output2 has characteristics similar to output1 when $lo_2 = 1.0 A$ and lo_1 varies.

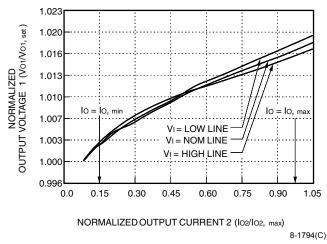
Figure 8. Lx010AJ Typical Cross Regulation, Vo1 vs. lo2 with Fixed lo1 = 1.0 A at Tc = 25 °C



Note: Output2 has characteristics similar to output1 when

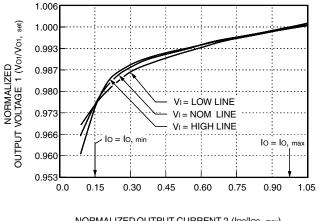
IO1 = (0.5 * IO, max) and IO2 varies.

Figure 9. Lx010BK, CL Load Regulation of Output1 with Fixed Io₂ = 0.5 * Io, max at Tc = 25 °C, Normalized Vo₁ vs. Normalized Current Io₁



Note: Output2 has characteristics similar to output1 when Io2 = Io, min and Io1 varies.

Figure 10. Lx010BK, CL Typical Cross Regulation, Normalized Vo1 vs. Normalized Io2 with Fixed Io1 = Io, min at Tc = 25 °C



NORMALIZED OUTPUT CURRENT 2 (Io2/Io2, max)

8-1795(C)

Note: Output2 has characteristics similar to output1 when Io2 = Io, max and Io1 varies.

Figure 11. Lx010BK, CL Typical Cross Regulation, Normalized Vo1 vs. Normalized lo2 with Fixed lo1 = lo, max at Tc = 25 °C

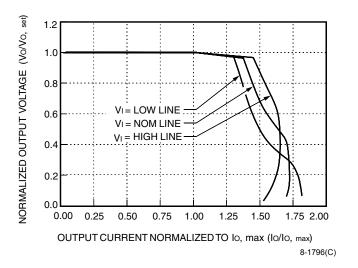
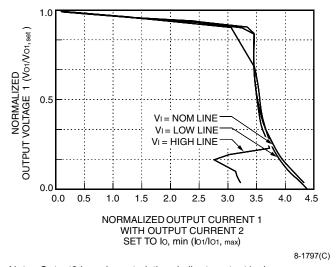
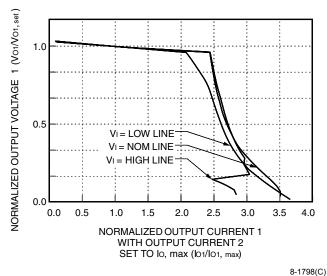


Figure 12. Lx010x/Lx015x Single-Output
Normalized Output Current vs.
Normalized Output Voltage at
Tc = 25 °C



Note: Output2 has characteristics similar to output1 when output1 is set to Io, min.

Figure 13. Lx010xx Dual-Output Normalized Output Current vs. Normalized Output Voltage at Tc = 25 °C with Other Output at Io, min



Note: Output2 has characteristics similar to output1 when output1 is set to Io, max.

Figure 14. Lx010xx Dual-Output Normalized Output Current vs. Normalized Output Voltage at Tc = 25 °C with Other Output at lo = lo, max

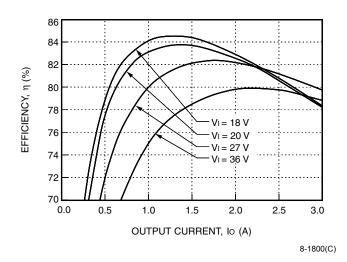


Figure 15. LC015A Typical Efficiency vs. Output

Current at Tc = 25 °C

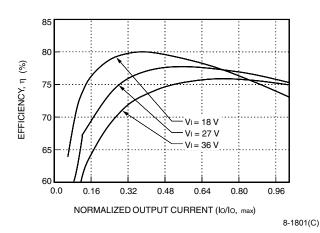


Figure 16. LC015B, C Typical Efficiency vs.

Normalized Output Current at Tc = 25 °C

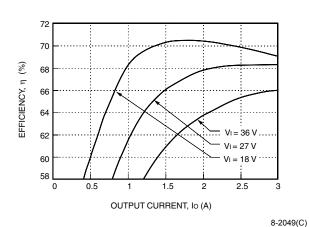


Figure 17. LC010D and LC015D Typical Efficiency vs. Output Current at Tc = 25 °C

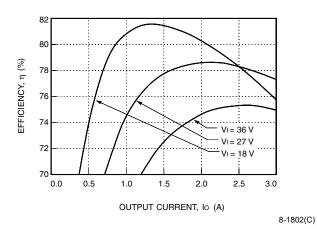


Figure 18. LC015F Typical Efficiency vs. Output Current at Tc = 25 °C

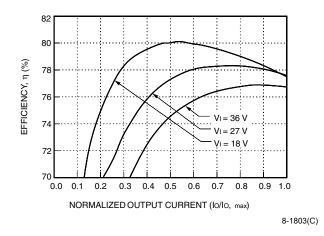


Figure 19. LC010A, B, C Typical Efficiency vs.

Normalized Output Current at Tc = 25 °C

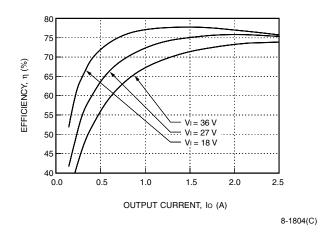


Figure 20. LC010F Typical Efficiency vs. Output Current at Tc = 25 °C

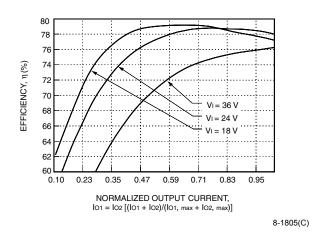


Figure 21. LC010AJ, BK, CL Typical Efficiency vs.

Normalized Output Current at Tc = 25 °C

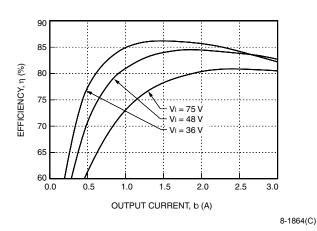


Figure 22. LW015A Typical Efficiency vs. Output Current at Tc = 25 °C

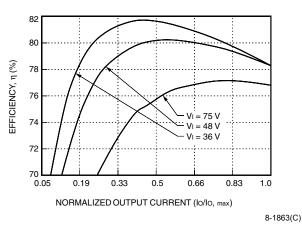


Figure 23. LW015B, C Typical Efficiency vs.

Normalized Output Current at Tc = 25 °C

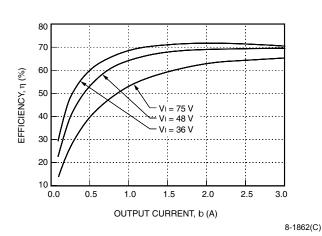


Figure 24. LW010D, 015D Typical Efficiency vs. Output Current at Tc = 25 °C

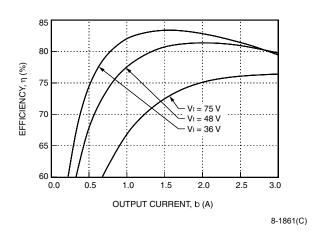


Figure 25. LW015F Typical Efficiency vs. Output

Current at Tc = 25 °C

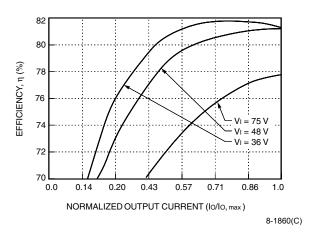


Figure 26. LW010A, B, C Typical Efficiency vs.

Normalized Output Current at Tc = 25 °C

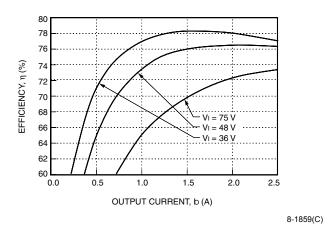


Figure 27. LW010F Typical Efficiency vs. Output Current at Tc = 25 °C

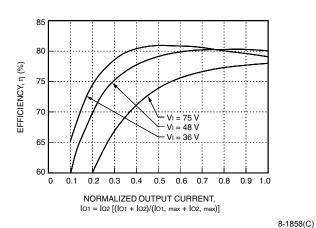


Figure 28. LW010AJ, BK, CL Typical Efficiency vs. Normalized Output Current at Tc = 25 °C

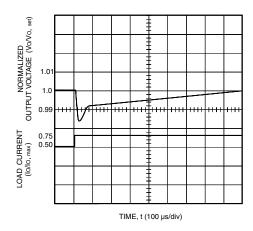


Figure 29. Single-Output Typical Output Voltage for Step Load Change from 50% to 75% of Io = Io, max

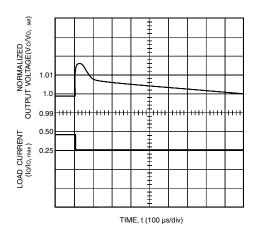


Figure 30. Single-Output Typical Output Voltage for Step Load Change from 50% to 25% of lo = lo, max

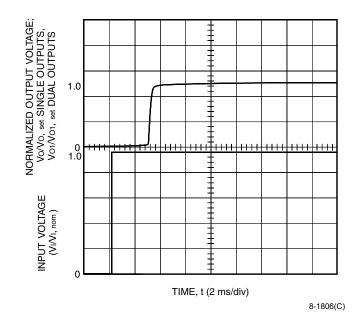


Figure 31. Typical Output Voltage Start-Up when Input Voltage Is Applied; Io = 80% of Io, max, VI = Nominal Line

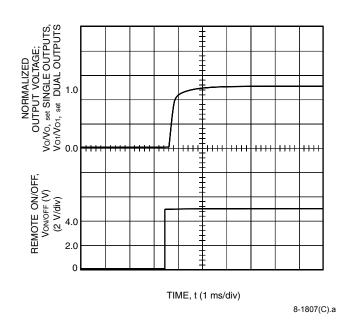


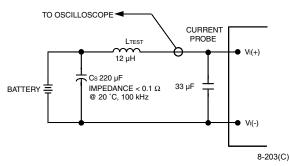
Figure 32. Typical Output Voltage Start-Up when Signal Is applied to Remote On/Off; Io = 80% of Io, max

Lineage Power 13

8-1856(C)

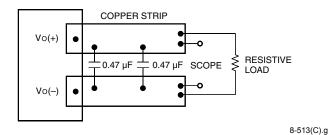
8-1857(C)

Test Configurations



Note: Input reflected-ripple current is measured with a simulated source impedance of 12 µH. Capacitor Cs offsets possible battery impedance. Current is measured at the input of the module.

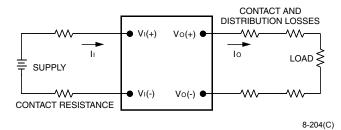
Figure 33. Input Reflected-Ripple Test Setup



Note: Use two 0.47 µF ceramic capacitors. Scope measurement should be made using a BNC socket. Position the load between 50 mm and 75 mm (2 in. and 3 in.) from the module.

Figure 34. Peak-to-Peak Output Noise

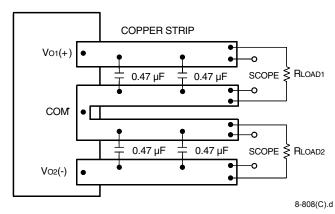
Measurement Test Setup for Single
Outputs



Note: All measurements are taken at the module terminals. When socketing, place Kelvin connections at module terminals to avoid measurement errors due to socket contact resistance.

$$\eta = \left(\frac{[VO(+)-VO(-)]IO}{[VI(+)-VI(-)]II}\right) \times 100$$

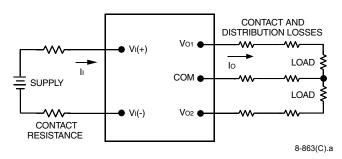
Figure 35. Output Voltage and Efficiency
Measurement Test Setup for Single
Outputs



Note: Use four 0.47 μF ceramic capacitors. Scope measurement should be made using a BNC socket. Position the load between 50 mm and 75 mm (2 in. and 3 in.) from the module.

Figure 36. Peak-to-Peak Output Noise

Measurement Test Setup for Dual
Outputs



Note: All measurements are taken at the module terminals. When socketing, place Kelvin connections at module terminals to avoid measurement errors due to socket contact resistance.

$$\eta = \left[\frac{\sum_{J=1}^{2} |[Vo_{J} - COM]Io_{J}|}{[V_{I}(+) - V_{I}(-)]I_{I}} \right] \times 100$$

Figure 37. Output Voltage and Efficiency
Measurement Test Setup for Dual
Outputs

Design Considerations

Input Source Impedance

The power module should be connected to a low ac-impedance input source. Highly inductive source impedances can affect the stability of the power module. If the source inductance exceeds 4 μH , a 33 μF electrolytic capacitor (ESR < 0.7 Ω at 100 kHz) mounted close to the power module helps ensure stability of the unit.

Safety Considerations

For safety-agency approval of the system in which the power module is used, the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standard, i.e., *UL* 1950, *CSA* 22.2 No. 950-95, EN60950, and IEC950.

For the converter output to be considered meeting the requirements of safety extra-low voltage (SELV), one of the following must be true of the dc input:

- All inputs are SELV and floating, with the output also floating.
- All inputs are SELV and grounded, with the output also grounded.
- Any non-SELV input must be provided with reinforced insulation from any other hazardous voltages, including the ac mains, and must have a SELV reliability test performed on it in combination with the converters.

The power module has extra-low voltage (ELV) outputs when all inputs are ELV.

The input to these units is to be provided with a maximum 5 A normal-blow fuse in the ungrounded lead.

Feature Descriptions

Output Overvoltage Clamp

The output overvoltage clamp consists of control circuitry, independent of the primary regulation loop, that monitors the voltage on the output terminals. This control loop has a higher voltage set point than the primary loop (see Feature Specifications table). In a fault condition, the overvoltage clamp ensures that the output voltage does not exceed VO, clamp, max. This provides a redundant voltage-control that reduces the risk of output overvoltage.

Current Limit

To provide protection in a fault (output overload) condition, the unit is equipped with internal current-limiting circuitry and can endure current limiting for an unlimited duration. At the point of current-limit inception, the unit shifts from voltage control to current control. If the output voltage is pulled very low during a severe fault, the current-limit circuit can exhibit either foldback or tailout characteristics (output-current decrease or increase). The unit operates normally once the output current is brought back into its specified range.

Remote On/Off (Optional)

Two remote on/off options are available. Positive logic, device code suffix "4", remote on/off turns the module on during a logic-high voltage on the remote ON/OFF pin, and off during a logic low. Negative logic, device code suffix "1", remote on/off turns the module off during a logic high and on during a logic low.

To turn the power module on and off, the user must supply a switch to control the voltage between the on/off terminal and the $V_{I}(-)$ terminal ($V_{on/off}$). The switch may be an open collector or equivalent (see Figure 38). A logic low is $V_{on/off} = -0.7$ V to +1.2 V. The maximum $I_{on/off}$ during a logic low is 1 mA. The switch should maintain a logic-low voltage while sinking 1 mA.

During a logic high, the maximum $V_{on/off}$ generated by the power module is 10 V. The maximum allowable leakage current of the switch at $V_{on/off}$ = 10 V is 50 μ A.

The module has internal capacitance to reduce noise at the ON/OFF pin. Additional capacitance is not generally needed and may degrade the start-up characteristics of the module.

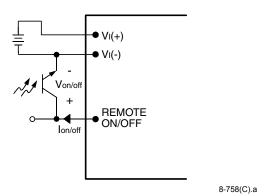


Figure 38. Remote On/Off Implementation

Feature Descriptions (continued)

Output Voltage Adjustment (Optional on Single-Output Units)

Output voltage set-point adjustment allows the user to increase or decrease the output voltage set point of a module. This is accomplished by connecting an external resistor between the TRIM pin and either the Vo(+) or Vo(–) pins. With an external resistor between the TRIM and Vo(+) pins (Radj-down), the output voltage set point (Vo, adj) decreases (see Figure 39). The following equation determines the required external resistor value to obtain an output voltage change from Vo, nom to Vo, adj:

$$\mathsf{R}_{\mathsf{adj}\text{-}\mathsf{down}} \, = \, \left[\frac{\left(\mathsf{Vo}, \mathsf{adj} - \mathsf{L} \right) \mathsf{G}}{\left(\mathsf{Vo}, \mathsf{nom} - \mathsf{Vo}, \mathsf{adj} \right)} - \mathsf{H} \right] \! \Omega$$

where Radj-down is the resistance value connected between TRIM and Vo(+), and G, H, and L are defined in the following table.

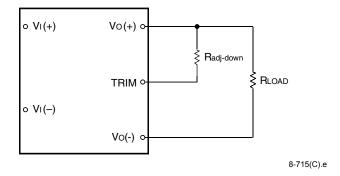


Figure 39. Circuit Configuration to Decrease Output Voltage

With an external resistor connected between the TRIM and $V_O(-)$ pins (R_{adj-up}), the output voltage set point (V_O , adj) increases (see Figure 40). The following equation determines the required external resistor value to obtain an output voltage from V_O , nom to V_O , adj:

$$R_{adj-up} = \left(\left[\frac{GL}{\left[(V_{O, adj} - L) - K \right]} \right] - H \right) \Omega$$

where Radj-up is the resistance value connected between TRIM and Vo (–), and the values of G, H, K, and L are shown in the following table:

	G	Н	K	L
Lx010, 5A	5110	2050	2.5	2.5
Lx010, 5B	10,000	5110	9.5	2.5
Lx010, 5C	10,000	5110	NA	2.5
Lx010, 5D	5110	2050	0.76	1.23
Lx010, 5F	5110	2050	0.75	2.5

The combination of the output voltage adjustment and the output voltage tolerance cannot exceed 110% (125% for the D) of the nominal output voltage between the Vo(+) and Vo(-) terminals.

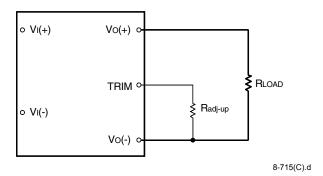


Figure 40. Circuit Configuration to Increase Output Voltage

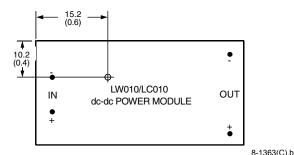
The L-Series power modules have a fixed current-limit set point. Therefore, as the output voltage is adjusted down, the available output power is reduced. In addition, the minimum output current is a function of the output voltage. As the output voltage is adjusted down, the minimum required output current can increase (i.e., minimum power is constant).

Synchronization (Optional)

With external circuitry, the unit is capable of synchronization from an independent time base with a switching rate of 256 kHz. Other frequencies may be available; please consult the factory for application guidelines and/or a description of the external circuit needed to use this feature.

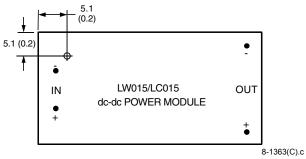
Thermal Considerations

The power module operates in a variety of thermal environments; however, sufficient cooling should be provided to help ensure reliable operation of the unit. Heat-dissipating components inside the unit are thermally coupled to the case. Heat is removed by conduction, convection, and radiation to the surrounding environment. Proper cooling can be verified by measuring the case temperature. The case temperature (Tc) should be measured at the position indicated in Figures 41 and 42.



Note: Dimensions are in millimeters and (inches). Pin locations are for reference only.

Figure 41. LW010 and LC010 Case Temperature Measurement Location



Note: Dimensions are in millimeters and (inches). Pin locations are for reference only.

Figure 42. LW015 and LC015 Case Temperature Measurement Location

Note that the views in Figures 41 and 42 are of the surface of the modules. The temperatures at these locations should not exceed the maximum case temperature indicated on the derating curve. The output power of the module should not exceed the rated power for the module as listed in the Ordering Information table.

Heat Transfer Characteristics

Increasing airflow over the module enhances the heat transfer via convection. Figures 43 through 45 show the maximum power that can be dissipated by the module without exceeding the maximum case temperature versus local ambient temperature (TA) for natural convection through 3.0 ms⁻¹ (600 ft./min.).

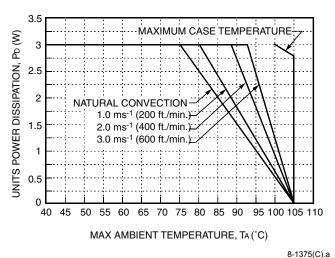
Systems in which these power modules are used typically generate natural convection airflow rates of 0.25 ms⁻¹ (50 ft./min.) due to other heat dissipating components in the system. Therefore, the natural convection condition represents airflow rates of approximately 0.25 ms⁻¹ (50 ft./min.). Use of Figure 43 is shown in the following example.

Example

What is the minimum airflow necessary for an LW010A operating at 48 V, an output current of 2.0 A, and a maximum ambient temperature of 91 °C?

Solution:

Given: $V_1 = 48 \text{ V}$, $I_0 = 2.0 \text{ A}$ (Io, max), $T_A = 91 \text{ °C}$ Determine P_D (Figure 58): $P_D = 2.5 \text{ W}$ Determine airflow (Figure 43): $v = 2.0 \text{ ms}^{-1}$ (400 ft./min.)



0-13/3(C).

Figure 43. LW010/LC010 Forced Convection Power Derating; Either Orientation

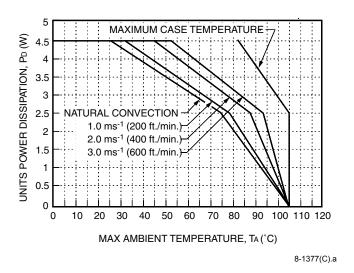


Figure 44. LC015 Forced Convection Power Derating; Either Orientation

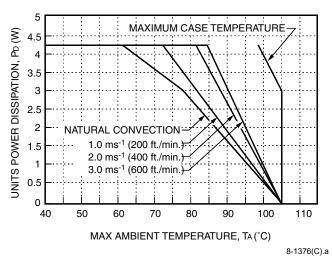
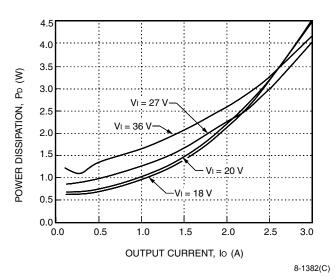


Figure 45. LW015 Forced Convection Power Derating; Either Orientation



Note: The power dissipation of this unit is shown at Tc = Tc, max because the efficiency of this power module drops at high temperatures.

Figure 46. LC015A Power Dissipation at Maximum Case Temperature

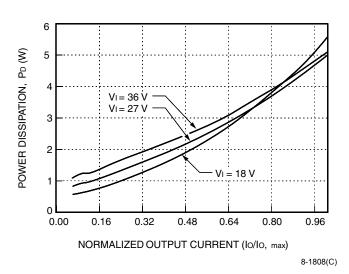


Figure 47. LC015B, C Typical Power Dissipation vs.

Normalized Output Current at Tc = 25 °C

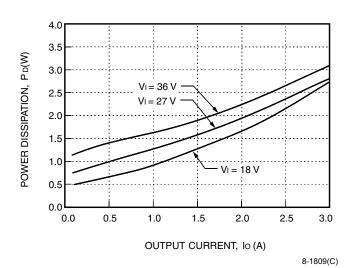
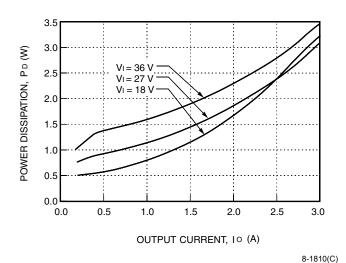


Figure 48. LC010D, 015D Typical Power Dissipation vs. Output Current at Tc = 25 °C



Note: The power dissipation of this unit is shown at Tc = Tc, max because the efficiency of this power module drops at high temperatures.

Figure 49. LC015F Typical Power Dissipation vs.
Output Current at Maximum Case
Temperature

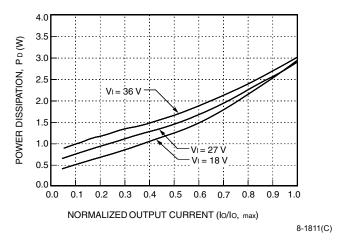


Figure 50. LC010A, B, C Typical Power Dissipation vs. Normalized Output Current at Tc = 25 °C

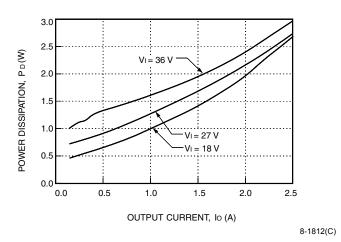


Figure 51. LC010F Typical Power Dissipation vs.
Output Current at Tc = 25 °C

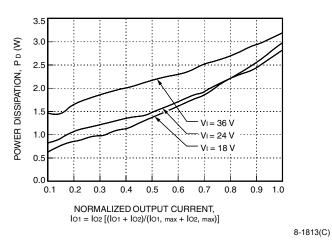
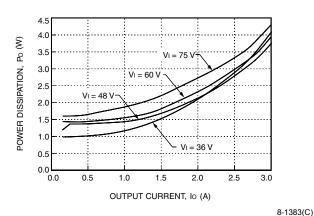


Figure 52. LC010AJ, BK, CL Typical Power
Dissipation vs. Normalized Output
Current at Tc = 25 °C



Note: The power dissipation of this unit is shown at Tc = Tc, max because the efficiency of this power module drops at high temperatures.

Figure 53. LW015A Power Dissipation at Maximum Case Temperature

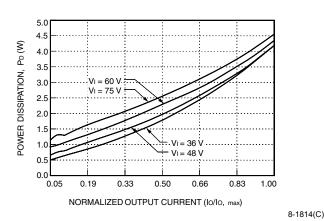


Figure 54. LW015B, C Typical Power Dissipation vs.

Normalized Output Current at Tc = 25 °C

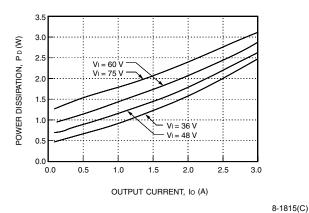


Figure 55. LW010D, LW015D Typical Power
Dissipation vs. Output Current at
Tc = 25 °C

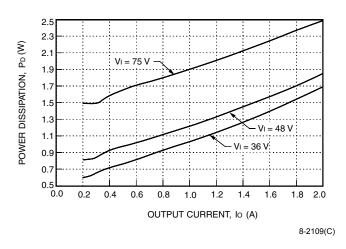
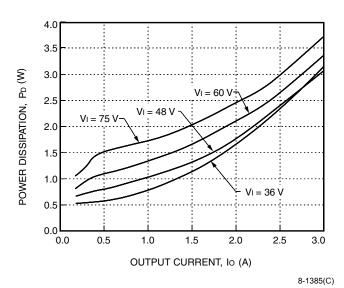


Figure 56. LW010D9 Typical Power Dissipation vs.
Output Current at Tc = 25 °C with Output
Voltage Trimmed Up to 2.5 V



Note: The power dissipation of this unit is shown at Tc = Tc, max because the efficiency of this power module drops at high temperatures.

Figure 57. LW015F Power Dissipation at Maximum Case Temperature

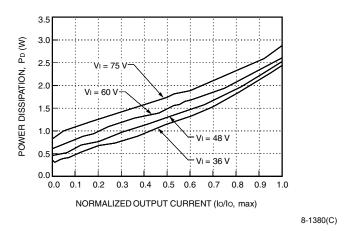


Figure 58. LW010A, B, C Typical Power Dissipation vs. Normalized Output Current at Tc = 25 °C

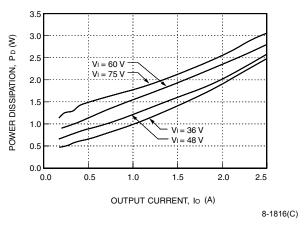


Figure 59. LW010F Typical Power Dissipation vs.
Output Current at Tc = 25 °C

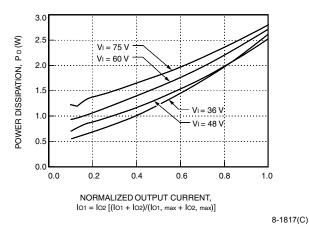
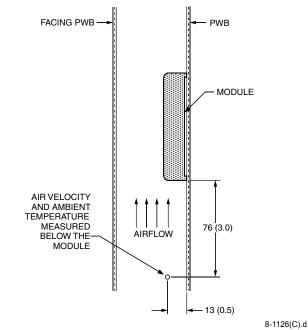


Figure 60. LW010AJ, BK, CL Typical Power
Dissipation vs. Normalized Output
Current at Tc = 25 °C

Module Derating

The derating curves in Figures 43 through 45 were determined by measurements obtained in an experimental apparatus shown in Figure 61. Note that the module and the printed-wiring board (PWB) that it is mounted on are both vertically oriented. The passage has a rectangular cross section.



Note: Dimensions are in millimeters and (inches).

Figure 61. Experimental Test Setup

Layout Considerations

Copper paths must not be routed beneath the power module standoffs.

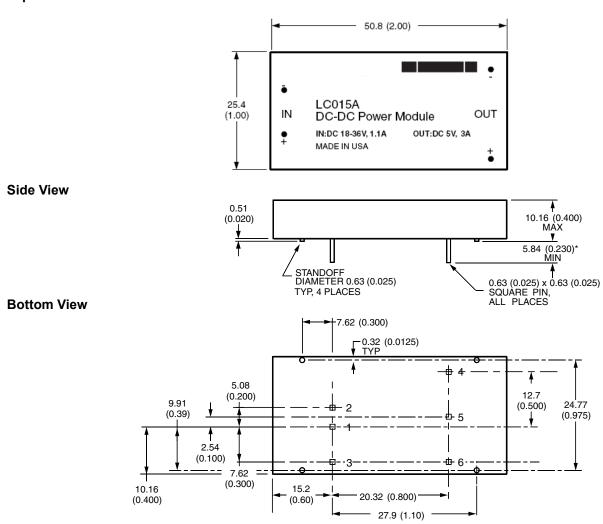
Outline Diagram

Dimensions are in millimeters and (inches).

Tolerance: $x.x \pm 0.5 \text{ mm}$ (0.020 in.); $x.xx \pm 0.38 \text{ mm}$ (0.015 in.).

If slightly lower height is needed, the four standoffs can be dropped through holes on the user's PWB. By dropping the standoffs through the PWB, the module height will be decreased to 9.5 mm (0.375 in.) typical height.

Top View



8-1329(C).b

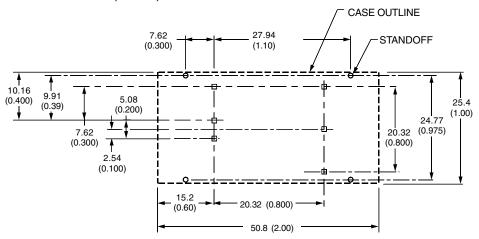
 $^{^{\}star}$ An optional short pin dimension is 2.8 mm \pm 0.25 mm (0.110 in. \pm 0.010 in.).

Pin	Function	Pin	Function
1	VI(-)	4	Vo(+) or Vo1(+)
2	VI(+)	5	COMMON (dual outputs) or TRIM (optional on single outputs) Pin is not present on single outputs unless option is specified. Pin is always present on dual outputs.
3	ON/OFF or SYNC (optional) Pin is not present unless one of these options is specified.	6	Vo(-) or Vo2(-)

Recommended Hole Pattern

Component-side footprint.

Dimensions are in millimeters and (inches).



8-1329(C).b

Ordering Information

Table 6. Device Codes

Input Voltage	Output Voltage	Output Power	Device Code	Comcode
18 V—36 V	5 V	15 W	LC015A	107809550
18 V—36 V	12 V	15 W	LC015B	107983140
18 V—36 V	15 V	15 W	LC015C	TBD
36 V—75 V	2 V	6 W	LC015D	TBD
18 V—36 V	3.3 V	10 W	LC015F	107809543
18 V—36 V	5 V	10 W	LC010A	107747925
18 V—36 V	12 V	10 W	LC010B	107747933
18 V—36 V	15 V	10 W	LC010C	107747941
18 V—36 V	2 V	4 W	LC010D	107747958
18 V—36 V	3.3 V	8 W	LC010F	107747966
18 V—36 V	±5 V	15 W	LC010AJ	107987083
18 V—36 V	±12 V	15 W	LC010BK	107809592
18 V—36 V	±15 V	15 W	LC010CL	TBD
36 V—75 V	5 V	15 W	LW015A	107809527
36 V—75 V	12 V	15 W	LW015B	107935413
36 V—75 V	15 V	15 W	LW015C	107935421
36 V—75 V	2 V	6 W	LW015D	107809501
36 V— 75 V	3.3 V	10 W	LW015F	107809535
36 V—75 V	5 V	10 W	LW010A	107747974
36 V—75 V	12 V	10 W	LW010B	107747982
36 V—75 V	15 V	10 W	LW010C	107747990
36 V—75 V	2 V	4 W	LW010D	107748006
36 V—75 V	3.3 V	8 W	LW010F	107748014
36 V—75 V	±5 V	10 W	LW010AJ	107935405
36 V—75 V	±12 V	10 W	LW010BK	107809568
36 V—75 V	±15 V	10 W	LW010CL	TBD

Ordering Information (continued)

Optional features may be ordered using the device code suffixes shown below. The feature suffixes are listed numerically in descending order. Please contact your Lineage Power Account Manager or Application Engineer for pricing and availability of options.

Table 7. Option Codes

Option	Device Code Suffix
Output voltage adjustment	9
Short pin: 2.8 mm ± 0.25 mm (0.110 in. ± 0.010 in.)	8
Short pin: 3.7 mm ± 0.25 mm (0.145 in. ± 0.010 in.)	6
Positive logic remote on/off	4
Synchronization (cannot be ordered on units with remote on/off)	3
Negative logic remote on/off	1



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